IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bot international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					aterials and	ials and Mfg Information				
Supplier	Information														
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
nsemi											2025-	2025-06-07			
Contact Na	ame		Title - Contact			1	Phone - Contact*				Emai	Email - Contact*			
Product-E	Env-Stewards		Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
uthorized	d Representative*		Title - Representative			I	Phone - Representative*				Emai	Email - Representative*			
Product-E	Env-Stewards		Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	Date Version Manufacturing Site		e	Weight*	UOM	Unit Type		
		HCPL2631SD 8PB 10M		8PB 10MB 2-CH T	B 10MB 2-CH T&R		2025-06-07					542.964	mg	Each	
<b>I</b> anufac	cturing Proccess Informa	ation											·	·	
	Terminal Plating / Grid Array Material Termi			erminal Base Alloy J-STD-020 MSL Rati			ng Peak Process Body Temperature Max Time at Pea			Peak Tempe	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU			U Alloy 1				225 C		30	sec	onds 3				
Comments															
evel 1 - ma	aximum time at peak temperat	ture during sol	dering is 10-3	0 seconds											
or more i	information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	64.0	mg	Supplier	3-Methacryloxypropyltrimethoxysilane (C10H20O5Si)	2530-85-0		64	mg
Die	0.099	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.033	mg
			Supplier	Silicon (Si)	7440-21-3		0.066	mg
Die Attach	0.25	mg	Supplier	Silver (Ag)	7440-22-4		0.2075	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0425	mg
Lead Frame	115.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.138	mg
			Supplier	Iron (Fe)	7439-89-6		2.7125	mg
			Supplier	Copper (Cu)	7440-50-8		112.125	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0245	mg
Mold Compound-Black	93.303	mg	Supplier	Brominated Epoxy Resin-2	68541-56-0		2.3325	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		13.995	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.866	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4695	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		65.31	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		9.33	mg
Mold Compound-White	258.662	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		52.4	mg
			Supplier	Zirconium Dioxide (ZrO2)	1314-23-4		1.3	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		196.662	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.6	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.7	mg
Plating	11.6	mg	Supplier	Tin (Sn)	7440-31-5		11.6	mg
Wire Bond - Au	0.05	mg	Supplier	Gold (Au)	7440-57-5		0.05	mg